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Vishay/Siliconix IRFP048PBF

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Datasheet of IRFP048PBF - MOSFET N-CH 60V 70A TO-247AC

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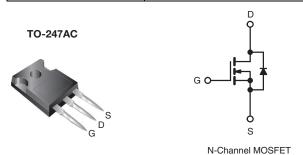


## **IRFP048, SiHFP048**

Vishay Siliconix

#### **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	6	60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V 0.018				
Q <sub>g</sub> (Max.) (nC)	1	110				
Q <sub>gs</sub> (nC)	2	29				
Q <sub>gd</sub> (nC)	38					
Configuration	Single					



#### **FEATURES**

- Dynamic dV/dt Rating
- Isolated Central Mounting Hole
- 175 °C Operating Temperature
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION			
Package	TO-247AC		
Lead (Pb)-free	IRFP048PbF		
Lead (PD)-Iree	SiHFP048-E3		
SnPb	IRFP048		
SHED	SiHFP048		

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	60	V	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Currente	V at 10.V	T <sub>C</sub> = 25 °C	I <sub>D</sub>	70		
Continuous Drain Current	VGS at 10 V			52	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	290	1	
Linear Derating Factor				1.3	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	200	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	190	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175		
Soldering Recommendations (Peak Temperature) <sup>d</sup> for 10 s				300	°C	
Mounting Torque	6 22 or l	0.00 140		10	lbf ⋅ in	
Mounting Torque	6-32 or M3 screw			1.1	N⋅m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 43  $\mu$ H,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 73 A (see fig. 12).
- c.  $I_{SD} \le 72$  A,  $dI/dt \le 200$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.
- d. 1.6 mm from case.

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- e. Current limited by the package (die current = 73 A).
- \* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.80		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0	V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I <sub>D</sub> = 1 mA	-	0.060	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{C}$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>S</sub> = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		$60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	25 250	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 44 \text{ A}^b$	-	-	0.018	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 2	5 V, I <sub>D</sub> = 44 A <sup>b</sup>	20	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	\ <u>\</u>	<sub>GS</sub> = 0 V,	-	2400	-	
Output Capacitance	C <sub>oss</sub>	V <sub>C</sub>	os = 25 V,	-	1300	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 ľ	MHz, see fig. 5	-	190	-	
Total Gate Charge	Qg	V <sub>GS</sub> = 10 V		-	-	110	nC
Gate-Source Charge	Q <sub>gs</sub>			-	-	29	
Gate-Drain Charge	Q <sub>gd</sub>		See fig. 6 dila 16	-	-	38	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 30 \text{ V}, I_D = 72 \text{ A}, \\ R_g = 9.1 \ \Omega, R_D = 0.34 \ \Omega, \text{ see fig. } 10^b$		-	8.1	-	ns
Rise Time	t <sub>r</sub>			-	250	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	210	-	
Fall Time	t <sub>f</sub>			-	250	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	5.0	-	
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	13	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		1	-	70°	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	290	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 73  \text{A},  V_{GS} = 0  V^b$		ı	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 72 A, dl/dt = 100 A/μs <sup>b</sup>		-	120	180	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.50	0.80	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )					L <sub>D</sub> )

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$
- c. Current limited by the package (die current = 73 A).



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

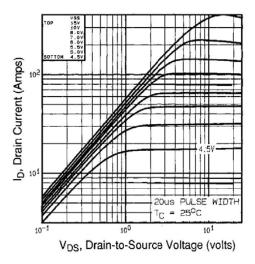


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

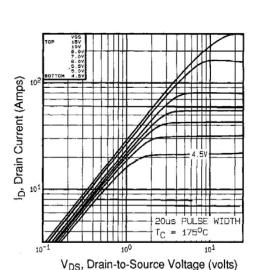


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

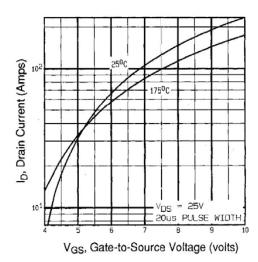


Fig. 3 - Typical Transfer Characteristics

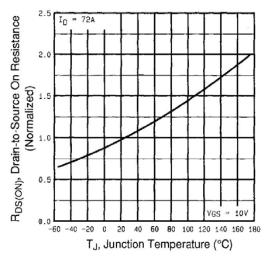


Fig. 4 - Normalized On-Resistance vs. Temperature

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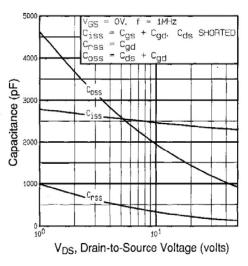


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

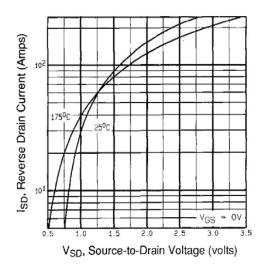


Fig. 7 - Typical Source-Drain Diode Forward Voltage

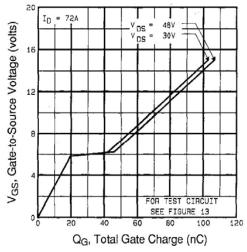


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

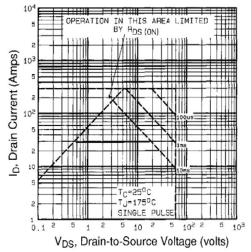


Fig. 8 - Maximum Safe Operating Area



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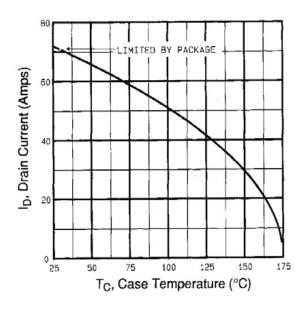


Fig. 9 - Maximum Drain Current vs. Case Temperature

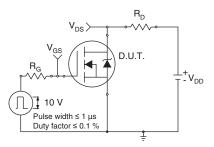


Fig. 10a - Switching Time Test Circuit

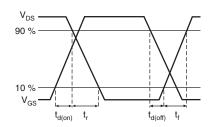


Fig. 10b - Switching Time Waveforms

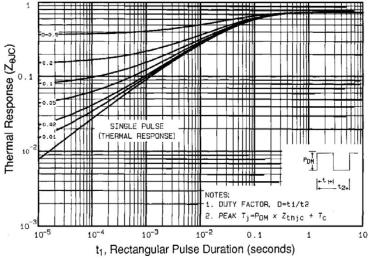


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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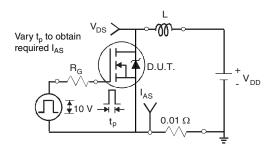


Fig. 12a - Unclamped Inductive Test Circuit

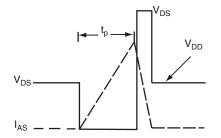


Fig. 12b - Unclamped Inductive Waveforms

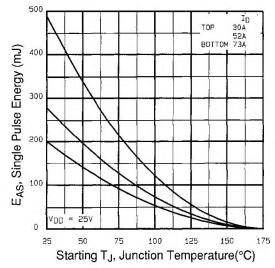


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

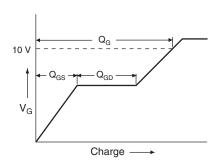


Fig. 13a - Basic Gate Charge Waveform

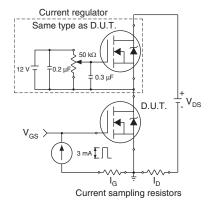


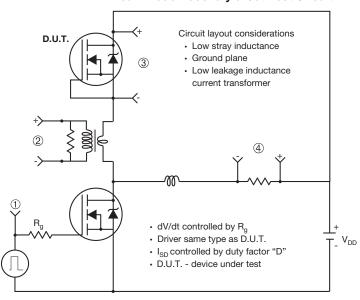
Fig. 13b - Gate Charge Test Circuit





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#### Peak Diode Recovery dV/dt Test Circuit



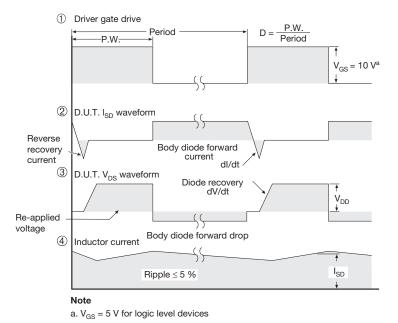


Fig. 14 - For N-Channel

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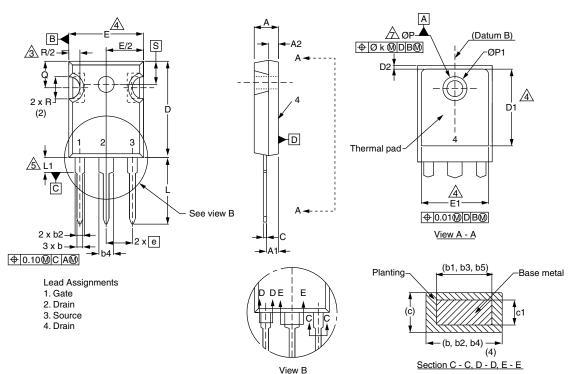
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# **Package Information**

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# **TO-247AC (High Voltage)**



	MILLIN	METERS	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.58	5.31	0.180	0.209
A1	2.21	2.59	0.087	0.102
A2	1.17	2.49	0.046	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.53	2.39	0.060	0.094
b3	1.65	2.37	0.065	0.093
b4	2.42	3.43	0.095	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.82	0.776	0.820
D1	13.08	_	0.515	-

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D2	0.51	1.30	0.020	0.051
E	15.29	15.87	0.602	0.625
E1	13.72	ı	0.540	ı
е	5.46	BSC	0.215	BSC
Øk	0.2	254	0.0	10
L	14.20	16.25	0.559	0.640
L1	3.71	4.29	0.146	0.169
N	7.62 BSC		0.300 BSC	
ØΡ	3.51	3.66	0.138	0.144
Ø P1	-	7.39	-	0.291
Q	5.31	5.69	0.209	0.224
R	4.52	5.49	0.178	0.216
S	5.51 BSC		0.217	BSC

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- Contour of slot optional.
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

  Thermal pad contour optional with dimensions D1 and E1.
- 5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.
- 8. Xian and Mingxin actually photo.



Revision: 01-Jul-13 Document Number: 91360



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